

) Preliminary Specifications

14.0" (13.98") HD+ 16:9 Color TFT-LCD with LED Backlight design			
Module			
Model Name	B140RW03 V1 (H/W:0A)		
Note (♠)	LED Backlight with driving circuit design		

Customer	Date
Checked & Approved by	Date

Note: This Specification is subject to change without notice.

Approved by	Date
Bonnie Chen	01/10/2011
Prepared by	Date
<u>HsinYin Yu</u>	01/10/2011

NBBU Marketing Division AU Optronics corporation



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Record of Revision

Ver	sion and Date Page		Old description	New Description	Remark
0.1	2010/10/05	All	First Edition for Customer		
		5	Wrong model name	Update correct model name	
0.2	2010/10/26	27	Old label information	Update label information	
		29	EDID TBD	New EDID information	
		5-6	General Specification TBD	Update Specification	
		13	Power Specification TBD	Update Power Specification	
0.3	2010/12/03	15	BLU power TBD	Update BLU power	
		19	Mating Housing TBD	Update Mating Housing	
			Old outline dimension	Update outline dimemsion	
1.0	1.0 2011/01/10	27	Old label information	Update label information	
		29-31	Old EDID information	Update EDID information	



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1. Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open nor modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
- 11)After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
- 12) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
- 13) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electrostic breakdown.



2. General Description

B140RW03 V1 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the 16:9 HD, 1600(H) x900(V) screen and 262k colors (RGB 6-bits data driver) with LED backlight driving circuit. All input signals are LVDS interface compatible.

B140RW03 V1 is designed for a display unit of notebook style personal computer and industrial machine.

2.1 General Specification

The following items are characteristics summary on the table at 25 °C condition:

Items	Unit	Specification	ons		
Screen Diagonal	[mm]	354.95			
Active Area	[mm]	309.60 X 17	74.15		
Pixels H x V		1600x3(RG	B) x 900		
Pixel Pitch	[mm]	0.1935X0.1	935		
Pixel Format		R.G.B. Vert	ical Stripe		
Display Mode		Normally W	hite		
White Luminance (ILED=20mA) (Note: ILED is LED current)	[cd/m ²]	300 typ. (5 points average)			
Luminance Uniformity		1.25 max. (5 points)			
Contrast Ratio		400 typ.			
Response Time	[ms]	8 typ / 16 Max			
Nominal Input Voltage VDD	[Volt]	+3.3 typ.			
Power Consumption	[Watt]	5.8 W (Inc	clude Logic a	and Blu pov	ver)
Weight	[Grams]	350 max.			
Physical Size			Min.	Тур.	Max.
Include bracket	[mm]	Length			324
	[]	Width			193
		Thickness			5.2
Electrical Interface		2 channel LVDS			
Glass Thickness	[mm]	0.5			
Surface Treatment		Anti-Glare, Hardness 3H,			
Support Color		262K colors	(RGB 6-bi	t)	



Temperature Range Operating Storage (Non-Operating)	[°C]	0 to +50 -20 to +60
RoHS Compliance		RoHS Compliance

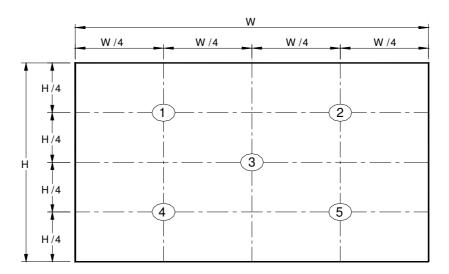
2.2 Optical Characteristics

The optical characteristics are measured under stable conditions at 25°C (Room Temperature):

Item		Symbol	Conditions	Min.	Тур.	Max.	Unit	Note
White Luminance ILED=20mA			5 points average	250	300	-	cd/m ²	1, 4, 5.
Viewing Angle		θ_R		40 40	45 45	-	degree	
viewing Ai	igie	Ψн Ψ∟	Vertical (Upper) CR = 10 (Lower)	10 30	15 35	-		4, 9
Luminan Uniformi		δ_{5P}	5 Points	-	-	1.25		1, 3, 4
Luminan Uniformi		δ _{13P}	13 Points	-	-	1.50		2, 3, 4
Contrast R	Contrast Ratio			300	400	-		4, 6
Cross ta	lk	%				4		4, 7
		T_r	Rising	-				
Response 7	Гime	T_f	Falling	-			msec	4, 8
		T_{RT}	Rising + Falling	-	8	16		
	Red	Rx		0.580	0.610	0.640		
	neu	Ry		0.320	0.350	0.380]	
	Cuaan	Gx		0.290	0.320	0.350		
Color /	Green	Gy		0.530	0.560	0.590		
Chromaticity Coodinates	Blue	Вх	CIE 1931	0.120	0.150	0.180		4
		Ву		0.100	0.130	0.160	-	
	\A/I ₀ !4 -	Wx		0.283	0.313	0.343		
	White	Wy		0.299	0.329	0.359		
NTSC		%			45			



Note 1: 5 points position (Ref: Active area)



Note 2: 13 points position (Ref: Active area)



Note 3: The luminance uniformity of 5 or 13 points is defined by dividing the maximum luminance values by the minimum test point luminance

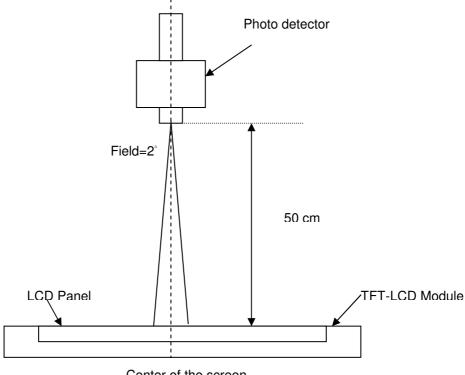
2	Maximum Brightness of five points	
δ _{w5} =	•	Minimum Brightness of five points
2		Maximum Brightness of thirteen points
$\delta_{\text{W13}} =$	_	Minimum Brightness of thirteen points

Note 4: Measurement method

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting



Backlight for 30 minutes in a stable, windless and dark room, and it should be measured in the center of screen.



Center of the screen

Note 5 Definition of Average Luminance of White (Y_L):

Measure the luminance of gray level 63 at 5 points , $Y_L = [L(1) + L(2) + L(3) + L(4) + L(5)] / 5$

L (x) is corresponding to the luminance of the point X at Figure in Note (1).

Note 6 : Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

Contrast ratio (CR)=
$$\frac{\text{Brightness on the "White" state}}{\text{Brightness on the "Black" state}}$$

Note 7: Definition of Cross Talk (CT)

$$CT = |Y_B - Y_A| / Y_A \times 100 (\%)$$

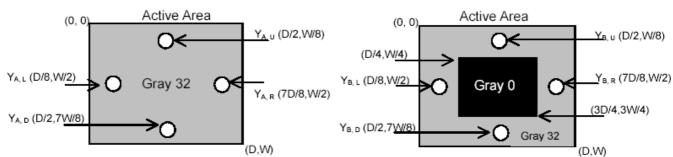
Where

Y_A = Luminance of measured location without gray level 0 pattern (cd/m₂)

Y_B = Luminance of measured location with gray level 0 pattern (cd/m₂)

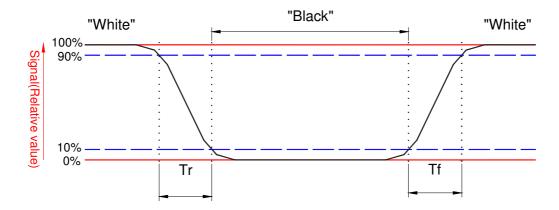


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Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from "Black" to "White" (falling time) and from "White" to "Black" (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.

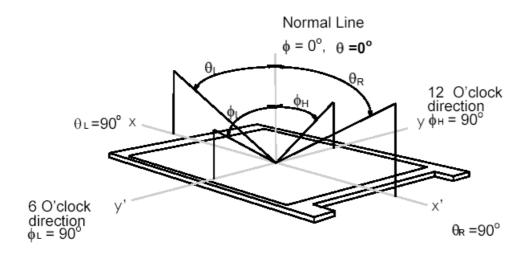




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Note 9. Definition of viewing angle

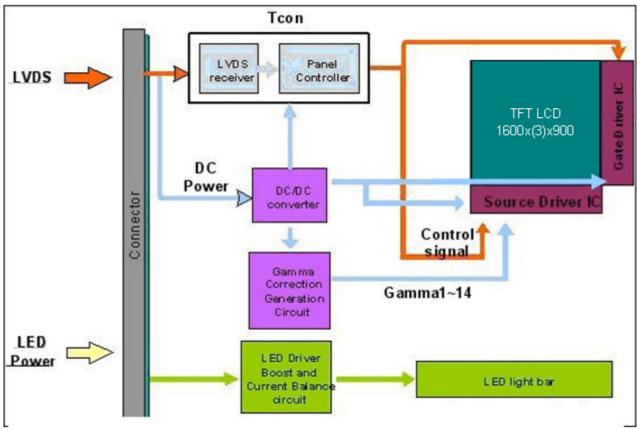
Viewing angle is the measurement of contrast ratio ≥ 10 , at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° (θ) horizontal left and right and 90° (Φ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.





3. Functional Block Diagram

The following diagram shows the functional block of the 14.0 inches wide Color TFT/LCD 40 Pin one channel Module





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4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.2 Absolute Ratings of Environment

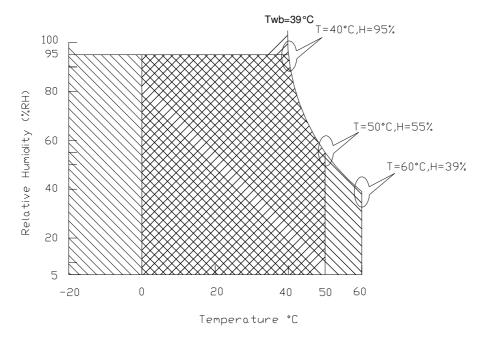
Item	Symbol	Min	Max	Unit	Conditions				
Operating Temperature	TOP	0	+50	[°C]	Note 4				
Operation Humidity	HOP	5	95	[%RH]	Note 4				
Storage Temperature	TST	-20	+60	[°C]	Note 4				
Storage Humidity	HST	5	95	[%RH]	Note 4				

Note 1: At Ta (25°C)

Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).



Operating Range

Storage Range

+

5. Electrical Characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

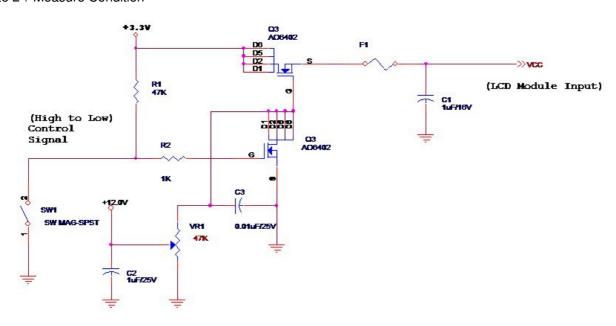
Input power specifications are as follows;

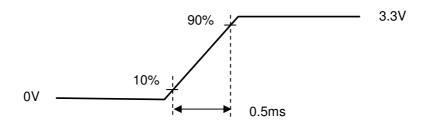
The power specification are measured under 25°C and frame frenquency under 60Hz

Symble	Parameter	Min	Тур	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	_	-	1.3	[Watt]	Note 1
IDD	IDD Current	-	-	0.43	[mA]	Note 1
IRush	Inrush Current	-	-	2000	[mA]	Note 2
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	100	[mV] p-p	

Note 1 : Maximum Measurement Condition : Black Pattern at 3.3V driving voltage. (P_{max}=V_{3.3} x I_{black})

Note 2: Measure Condition





Vin rising time



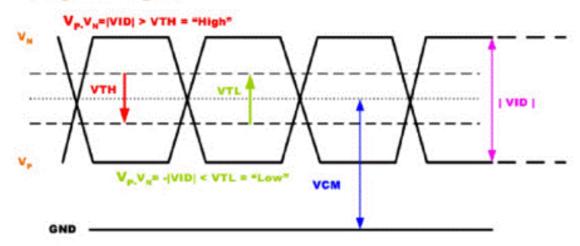
5.1.2 Signal Electrical Characteristics

Signal electrical characteristics are as follows;

Parameter	Condition	Min	Max	Unit
V _{TH}	Differential Input High Threshold (Vcm=+1.2V)		100	[mV]
V _{TL}	Differential Input Low Threshold (Vcm=+1.2V)	-100	-	[mV]
V _{CM}	Differential Input Common Mode Voltage	1.125	1.375	[V]

Note: LVDS Signal Waveform

Single-end Signal





5.2.1 LED characteristics

Parameter	Symbol	Min	Тур	Max	Units	Condition
Backlight Power Consumption	PLED	-	-	4.5	[Watt]	(Ta=25°C), Note 1 Vin =12V
LED Life-Time	N/A	10000	-	-	Hour	(Ta=25°C), Note 2
						I _F =20 mA

Note 1: Calculator value for reference P_{LED} = VF (Normal Distribution) * IF (Normal Distribution) / Efficiency

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous.

5.2.2 Backlight input signal characteristics

Parameter	Symbol	Min	Тур	Max	Units	Remark
LED Power Supply	VLED	6.0	12.0	21.0	[Volt]	
LED Enable Input High Level	VLED EN	2.5	-	5.5	[Volt]	
LED Enable Input Low Level	VLED_EN	-	-	0.8	[Volt]	Define as
PWM Logic Input High Level	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	2.5	-	5.5	[Volt]	Connector Interface
PWM Logic Input Low Level	VPWM_EN	-	-	0.8	[Volt]	(Ta=25°C)
PWM Input Frequency	FPWM	200	-	20K	Hz	
PWM Duty Ratio	Duty	5		100	%	



6. Signal Interface Characteristic

6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.

	1						16	00
1st Line	R G B	R G B		R	G	В	R (G B
			•					
			•					
			· ·					
	1		•					
			f .					
	'	'	ĺ		1			1
900th Line	R G B	R G B		R	G	В	R	G B

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6.2 The Input Data Format





Signal Name	Description	
R5	Red Data 5 (MSB)	Red-pixel Data
R4	Red Data 4	Each red pixel's brightness data consists of
R3	Red Data 3	these 6 bits pixel data.
R2	Red Data 2	those o blie pixel data.
R1	Red Data 1	
R0	Red Data 0 (LSB)	
	(202)	
	Red-pixel Data	
G5	Green Data 5 (MSB)	Green-pixel Data
G4	Green Data 4	Each green pixel's brightness data consists of
G3	Green Data 3	these 6 bits pixel data.
G2	Green Data 2	
G1	Green Data 1	
G0	Green Data 0 (LSB)	
	Our en missel Date	
DE	Green-pixel Data	Discovery of Date
B5	Blue Data 5 (MSB)	Blue-pixel Data
B4 B3	Blue Data 4 Blue Data 3	Each blue pixel's brightness data consists of these 6 bits pixel data.
B2	Blue Data 2	triese o bits pixei data.
B1	Blue Data 1	
B0	Blue Data 0 (LSB)	
B0	Bide Baid 6 (LOB)	
	Blue-pixel Data	
RxCLKIN	Data Clock	The signal is used to strobe the pixel data and
		DE signals. All pixel data shall be valid at the
		falling edge when the DE signal is high.
DE	Display Timing	This signal is strobed at the falling edge of
		RxCLKIN. When the signal is high, the pixel
1/0	N 1.0	data shall be valid to be displayed.
VS	Vertical Sync	The signal is synchronized to RxCLKIN.
HS	Horizontal Sync	The signal is synchronized to RxCLKIN.

Note: Output signals from any system shall be low or High-impedance state when VDD is off.



6.3 Integration Interface Requirement

6.3.1 Connector Description

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

Connector Name / Designation	For Signal Connector
Manufacturer	JAE or Compatiable
Type / Part Number	JAE HD1S040HA1 or Compatiable
Mating Housing/Part Number	I-PEX 20453-040T-12 or Compatiable

6.3.2 Pin Assignment

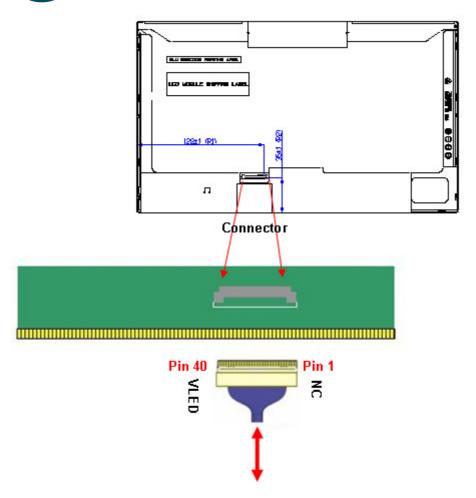
LVDS is a differential signal technology for LCD interface and high speed data transfer device.

PIN#	SIGNAL NAME	DESCRIPTION
1	NC	NC
2	VDD	+ 3.3V Power Supply
3	VDD	+ 3.3V Power Supply
4	VEDID	+ 3.3V EDID Power
5	N.C	No Connect.
6	CLKEDID	EDID Clock Input
7	DATAEDID	EDID Data Input
8	Odd_Rin0-	-LVDS Differential Data Input
9	Odd_Rin0+	+LVDS Differential Data Input
10	VSS	Power Ground
11	Odd_Rin1-	-LVDS Differential Data Input
12	Odd_Rin1+	+LVDS Differential Data Input
13	VSS	Power Ground
14	Odd_Rin2-	-LVDS Differential Data Input
15	Odd_Rin2+	+LVDS Differential Data Input
16	VSS	Power Ground
17	Odd_ClkIN-	-LVDS Differential Clock Input
18	Odd_ClkIN+	+LVDS Differential Clock Input
19	VSS	Ground
20	Even_Rin0-	-LVDS Differential Data Input
21	Even_Rin0+	+LVDS Differential Data Input



22	VSS	Power Ground
23	Even_Rin1-	-LVDS Differential Data Input
24	Even_Rin1+	+LVDS Differential Data Input
25	VSS	Power Ground
26	Even_Rin2-	-LVDS Differential Data Input
27	Even_Rin2+	+LVDS Differential Data Input
28	VSS	Power Ground
29	Even_ClkIN-	-LVDS Differential Clock Input
30	Even_ClkIN+	+LVDS Differential Clock Input
31	VLED_GND	LED_GND
32	VLED_GND	LED_GND
33	VLED_GND	LED_GND
34	NC	NC
35	S-PWM	
36	LED_EN	
37	NC	NC
38	VLED	LED_Positive (6~21)
39	VLED	LED_Positive(6~21)
40	VLED	LED_Positive(6~21)

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Note1: Input signals shall be low or High-impedance state when VDD is off.

6.4 Interface Timing

6.4.1 Timing Characteristics

Basically, interface timings should match the 1600x900 /60Hz manufacturing guide line timing.

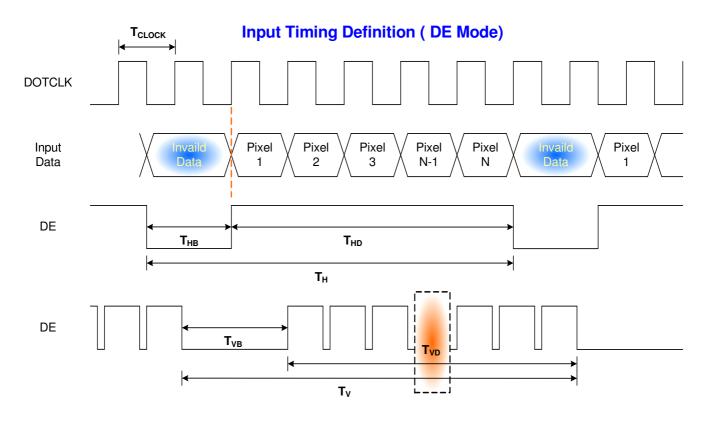
Parameter		Symbol	Min.	Тур.	Max.	Unit
Frame	Frame Rate			60		Hz
Clock frequency		1/ T _{Clock}		55		MHz
	Period	T _V	908	912	2047	
Vertical	Active	T _{VD}	900		T_Line	
Section	Blanking	T _{VB}	8	12	•	
	Period	T _H	840	1006	2047	
Horizontal	Active	T _{HD}		800		T_{Clock}
Section	Blanking	T HB	40	206		

Note: DE mode only

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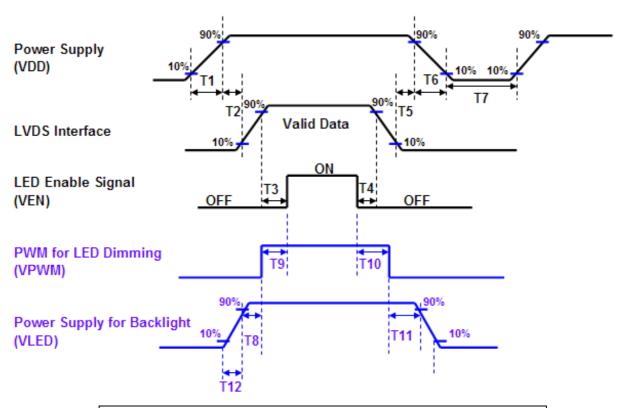




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6.5 Power ON/OFF Sequence

VDD power on/off sequence is as follows. Interface signals are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off



Power Sequence Timing						
	Val	Value				
Parameter	Min.	Max.	Units			
T1	0.5	10				
T2	0	50				
Т3	250	-				
T4	200	-				
T5	0	50				
T6	0	10				
T7	500	-	ms			
Т8	10	-				
Т9	10	180				
T10	10	180				
TII	10	-				
T12	0.5	10				



7. Panel Reliability Test

7.1 Vibration Test

Test Spec:

Test method: Non-Operation

Acceleration: 1.5 G

Frequency: 10 - 500Hz Random

Sweep: 30 Minutes each Axis (X, Y, Z)

7.2 Shock Test

Test Spec:

Test method: Non-Operation

Acceleration: 220 G, Half sine wave

Active time: 2 ms

Pulse: X,Y,Z .one time for each side

7.3 Reliability Test

Items	Required Condition	Note
Temperature Humidity Bias	Ta= 40℃, 90%RH, 300h	
High Temperature Operation	Ta= 50℃, Dry, 300h	
Low Temperature Operation	Ta= 0℃, 300h	
High Temperature Storage	Ta= 60℃, 35%RH, 300h	
Low Temperature Storage	Ta= -20℃, 50%RH, 250h	
Thermal Shock Test	Ta=-20℃to 60℃, Duration at 30 min, 100 cycles	
ESD	Contact : ±8 KV Air : ±15 KV	Note 1

Note1: According to EN 61000-4-2, ESD class B: Some performance degradation allowed. No data lost

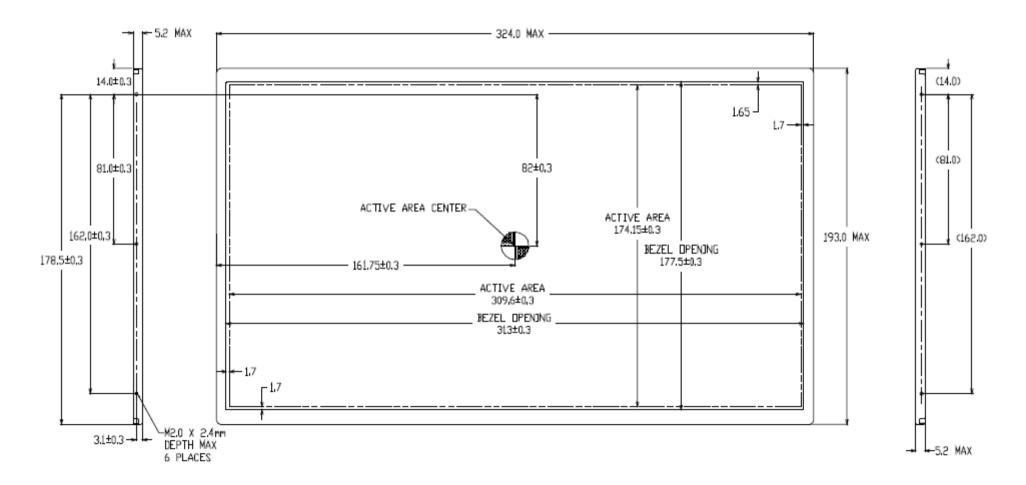
. Self-recoverable. No hardware failures.

Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 90%

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8. Mechanical Characteristics

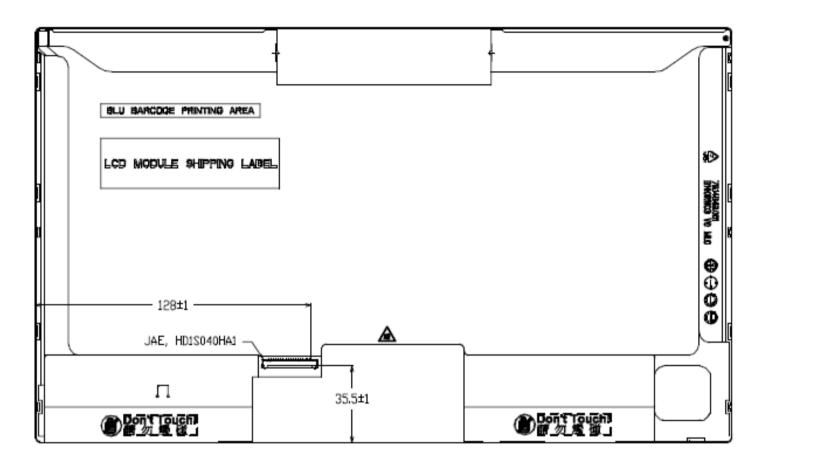
8.1 LCM Outline Dimension



1.14.0' LCD module mechanical outline dimension

- 2. All dimension in mm
- 3. As viewed from front of LCD nodules

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- 1. 14.0' LCD module mechanical outline dimension
- 2. All dimension in mm
- 3. As yiewed from back of LCD modules

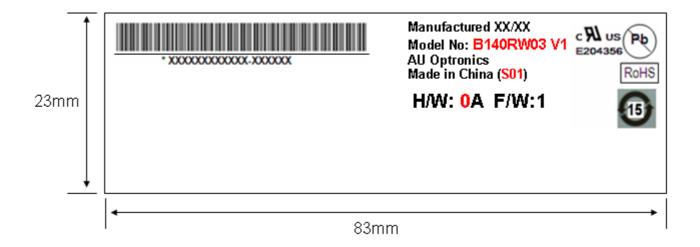
Note: Prevention IC damage, IC positions not allowed any overlap over these areas

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9. Shipping and Package

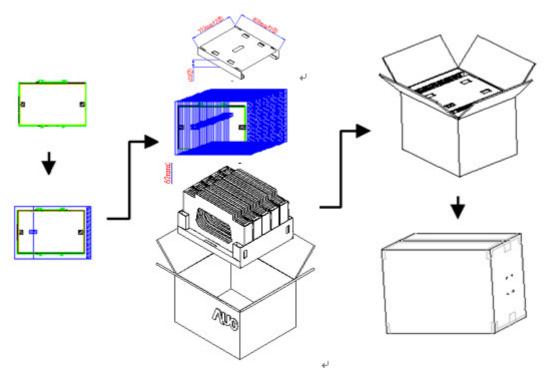
9.1 Shipping /Carton Label Format



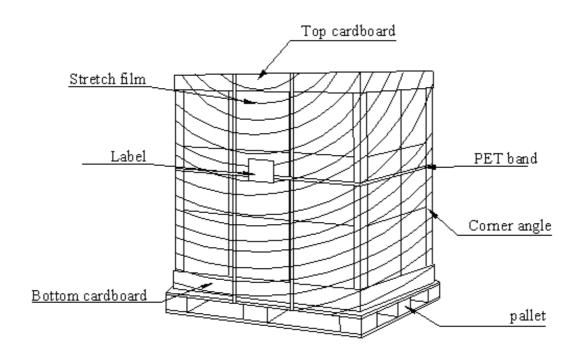


9.2 Carton Package

The outside dimension of carton is 455 (L)mm x 380 (W)mm x 355 (H)mm



9.3 Shipping Package of Palletizing Sequence



10. Appendix: EDID Description

Address	FUNCTION	Value	Value	Value	Note
HEX		HEX	BIN	DEC	
00	Header	00	00000000	0	
01		FF	11111111	255	
02		FF	11111111	255	
03		FF	11111111	255	
04		FF	11111111	255	
05		FF	11111111	255	
06		FF	11111111	255	
07		00	00000000	0	
08	EISA Manuf. Code LSB	06	00000110	6	
09	Compressed ASCII	AF	10101111	175	
0A	Product Code	3E	00111110	62	
0B	hex, LSB first	31	00110001	49	
0C	32-bit ser #	00	00000000	0	
0D		00	00000000	0	
0E		00	00000000	0	
0F		00	00000000	0	
10	Week of manufacture	21	00100001	33	
11	Year of manufacture	14	00010100	20	
12	EDID Structure Ver.	01	0000001	1	
13	EDID revision #	04	00000100	4	
14	Video input def. (digital I/P, non-TMDS, CRGB)	90	10010000	144	
15	Max H image size (rounded to cm)	1F	00011111	31	
16	Max V image size (rounded to cm)	11	00010001	17	
17	Display Gamma (=(gamma*100)-100)	78	01111000	120	
18	Feature support (no DPMS, Active OFF, RGB, tmg Blk#1)	02	00000010	2	
19	Red/green low bits (Lower 2:2:2:2 bits)	CC	11001100	204	
1A	Blue/white low bits (Lower 2:2:2:2 bits)	CE	11001110	206	
1B	Red x (Upper 8 bits)	99	10011001	153	
1C	Red y/ highER 8 bits	58	01011000	88	
1D	Green x	50	01010000	80	
1E	Green y	8E	10001110	142	
1F	Blue x	26	00100110	38	
20	Blue y	24	00100100	36	
21	White x	4B	01001011	75	
22	White y	53	01010011	83	
23	Established timing 1	00	00000000	0	
24	Established timing 2	00	00000000	0	
25	Established timing 3	00	00000000	0	
26	Standard timing #1	01	00000001	1	
27	_	01	00000001	1	
28	Standard timing #2	01	00000001	1	
29		01	00000001	1	
2A	Standard timing #3	01	00000001	1	
2B		01	00000001	1	

2C	Standard timing #4	01	00000001	1		
2D		01	0000001	1		
2E	Standard timing #5	01	0000001	1		
2F	Commence and the commence of t	01	00000001	1		
30	Standard timing #6	01	0000001	1		
31	Standard thing #5	01	0000001	1		
32	Standard timing #7	01	0000001	1	1	
33		01	0000001	1		
34	Standard timing #8	01	0000001	1		
35	otandara tining #0	01	0000001	1	1	
36	Pixel Clock/10000 LSB	B0	10110000	176		
37	Pixel Clock/10000 USB	2C	00101100	44		
38	Horz active Lower 8bits	40	01000000	64	1	
39	Horz blanking Lower 8bits	CE	11001110	206	+	
3A	HorzAct:HorzBlnk Upper 4:4 bits	61	01100001	97	+	
3B	Vertical Active Lower 8bits	84	10000100	132	†	
3C	Vertical Blanking Lower 8bits	18	0001100	24	+	
3D	Vert Act : Vertical Blanking (upper 4:4 bit)	30	00011000	48	†	
3E	HorzSync. Offset	40	01000000	64	+	
3F	HorzSync.Width	2A	00101010	42	+	
40	VertSync.Offset : VertSync.Width	33	00101010	51	+	
41	Horz‖ Sync Offset/Width Upper 2bits	00	00000000	0	+	
42	Horizontal Image Size Lower 8bits	35	0000000	53	1	
43	Vertical Image Size Lower 8bits	AE	10101110	174	+	
	Horizontal & Vertical Image Size (upper 4:4 bits)				+	
44 45	Horizontal Border (zero for internal LCD)	10	00010000	16	+	
45	Vertical Border (zero for internal LCD)	00	00000000	0	-	
	Signal (non-intr, norm, no stero, sep sync, neg pol)		00000000	_	+	
47	• • • • • • • • • • • • • • • • • • • •	18 CB	00011000	24	+	
48	Detailed timing/monitor	CB 1D	11001011 00011101	203 29	+	
	descriptor #2	40			+	
4A 4B		İ	01000000	64	+	
4C		CE	11001110	206	+	
4C 4D		61	01100001	97	+	
4B 4E		18	10000100	132	+	
4E 4F			00011000	24	+	
		30	00110000	48	+	
50		40	01000000	64	-	
51		2A	00101010	42	+	
52		33	00110011	51	+	
53		00	00000000	0 F2	+	
54		35	00110101	53	+	
55 56		AE 10	10101110	174	+	
56		10	00010000	16	1	
57		00	00000000	0	1	
58		00	00000000	0	+	
59	B. 11. 11. 1. 1.	18	00011000	24	+	
5A	Detailed timing/monitor	00	00000000	0	+	
5B	descriptor #3	00	00000000	0	+	
5C		00	00000000	0	00 1 01	
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5D		FE	11111110	254		
5E		00	00000000	0		
5F	Manufacture	41	01000001	65	Α	
60	Manufacture	55	01010101	85	U	
61	Manufacture	4F	01001111	79	0	
62		0A	00001010	10		
63		20	00100000	32		
64		20	00100000	32		
65		20	00100000	32		
66		20	00100000	32		
67		20	00100000	32		
68		20	00100000	32		
69		20	00100000	32		
6A		20	00100000	32		
6B		20	00100000	32		
6C	Detailed timing/monitor	00	00000000	0		
6D	descriptor #4	00	00000000	0		
6E		00	00000000	0		
6F		FE	11111110	254		
70		00	00000000	0		
71	Manufacture P/N	42	01000010	66	В	
72	Manufacture P/N	31	00110001	49	1	
73	Manufacture P/N	34	00110100	52	4	
74	Manufacture P/N	30	00110000	48	0	
75	Manufacture P/N	52	01010010	82	R	
76	Manufacture P/N	57	01010111	87	W	
77	Manufacture P/N	30	00110000	48	0	
78	Manufacture P/N	33	00110011	51	3	
79	Manufacture P/N	20	00100000	32		
7 A	Manufacture P/N	56	01010110	86	V	
7B	Manufacture P/N	31	00110001	49	1	
7C		20	00100000	32		
7D		0A	00001010	10		
7E	Extension Flag	00	00000000	0		
7F	Checksum	C4	11000100	196		
SUM 7680						